

PLCC Series

ET-5050H-3F1W Neutral White Datasheet

Ultra high luminous efficacy, combined with the flexibility in design due to its slim and miniature size, PLCC LED Series are optimized to be used as lighting for building.



Features :

- High luminous Intensity and high efficiency
- Based on InGaN / GaN technology
- Wide viewing angle : 120°
- Excellent performance and visibility
- Suitable for all SMT assembly methods
- IR reflow process compatible
- Environmental friendly; RoHS compliance
- High color rendering index

Typical Applications

- Signal and Symbol Luminaire
- Indoor and Outdoor Displays
- Backlighting (illuminated advertising, general lighting)
- Interior Automotive Lighting



Lighting Design Manufacturing Service

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Product Nomenclature

The following table describes the available color, power, and lens type. For more flux and forward voltage information, please consult the Bin Group document.

E T - 5050 H - 3 F 1 W

X1 X2 X3 X4 X5 X6 X7

X1 LED Item		X2 Package Type		X3 Emitting Color		X4 Chip Quantity		X5~X6 Serial No.	X7 Feature	
Code	Type	Code	Type	Code	Type	Code	Type		Code	Type
ET	Edison Top LED	3528	3.5x2.8mm	W	Cool White	1	1pcs		W	White surface
		5050	5.0x5.0mm	H	Neutral White	3	3pcs		B	Black surface
				X	Warm White	A	0.5W		D	Black housing
				R	Red	B	1W			
				A	Amber(615nm)					
				Y	Yellow(590nm)					
				T	True Green					
				B	Blue					
				RTB	RGB 3chips					

Figure 1. PLCC 5050 series Nomenclature

Environmental Compliance

PLCC 5050 series are compliant to the Restriction of Hazardous Substances Directive or RoHS. The restricted materials including lead, mercury cadmium hexavalent chromium, polybrominated biphenyls (PBB) and polybrominated diphenyl ether (PBDE) are not used in PLCC 5050 series to provide an environmentally friendly product to the customers.

LED Package Dimension and Polarity

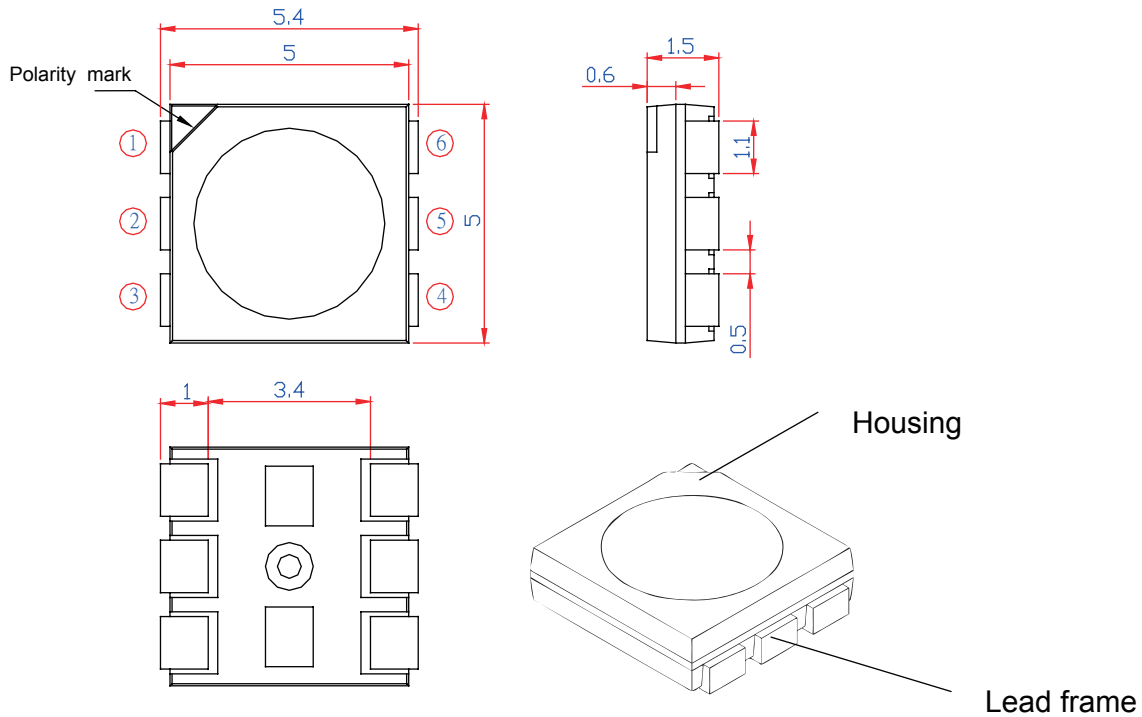


Figure 2. PLCC 5050 series Dimension

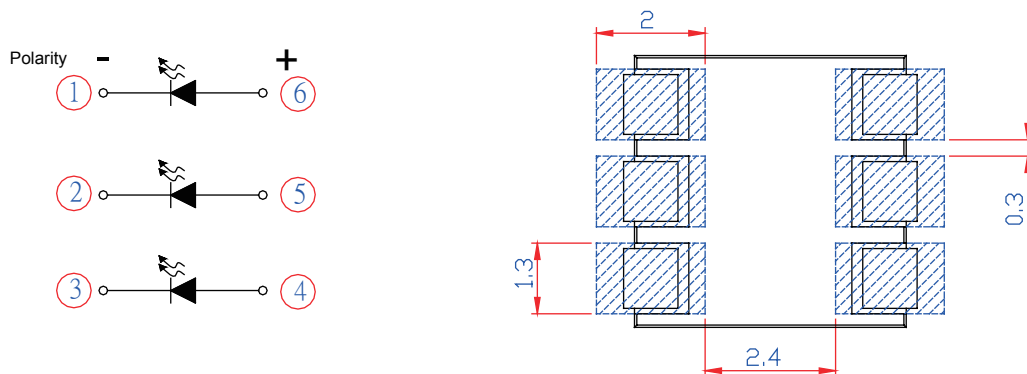


Figure 3. PLCC 5050 series circuit diagram

Notes:

1. All dimensions are measured in mm.
2. Tolerance : ± 0.2 mm

Absolute Maximum Ratings

The following table describe absolute maximum ratings of PLCC 5050 series.

Table 1. Absolute maximum ratings for PLCC 5050 series (per chip)

Parameter	Rating	Units	Symbol
Forward Current	30	mA	I_F
Pulse Forward Current ($t_p \leq 100\mu s$, Duty cycle=0.25)	100	mA	
Reverse Voltage	5	V	V_R
Forward Voltage	3.8	V	V_F
Power Dissipation	115	mW	
LED Junction Temperature	125	$^{\circ}C$	T_J
Operating Temperature	-30 ~ +85	$^{\circ}C$	
Storage Temperature	-40 ~ +100	$^{\circ}C$	
Soldering Temperature	255~260	$^{\circ}C$	
Manual Soldering at 350 $^{\circ}C$ (Max.)	3	Sec	

Notes:

1. Above values are based on 1-chip performance.
2. Proper current derating must be observed to maintain junction temperature below the maximum at all time.
3. LEDs are not designed to be driven in reverse bias.
4. t_p : Pulse width time

Luminous Intensity Characteristic

The following table describes luminous intensity of PLCC 5050 series.

Table 2. Luminous intensity characteristics at $I_F=20mA$ /chip and $T_a=25^{\circ}C$ for PLCC 5050 series

Part Name	Color	Luminous intensity(mcd)			Luminous Flux Typ.(lm)
		Min.	Typ.	Max.	
ET-5050H-3F1W	Neutral White	4,850	5,400	--	16.2

Note:

Luminous intensity is measured with an accuracy of $\pm 10\%$

Forward Voltage Characteristic

The following table describes forward voltage of PLCC 5050 series.

Table 3 . Forward voltage characteristic at $I_F=20\text{mA}/\text{chip}$ and $T_a=25^\circ\text{C}$ for PLCC 5050

Part Name	Color	V_F			Unit
		Min.	Typ.	Max.	
ET-5050H-3F1W	Neutral White	2.8	--	3.8	V

Note:

Forward Voltage is measured with an accuracy of $\pm 0.1\text{V}$

Color Temperature Characteristic

The following table describes forward voltage of PLCC 5050 series

Table 4 . Color Rendering Index Characteristics at $T_j=25^\circ\text{C}$ for PLCC 5050 series

Part Name	Color	CRI
		Typ.
ET-5050H-3F1W	Neutral White	75

Note:

CRI is measured with an accuracy of ± 5

JEDEC Information

JEDEC is used to determine what classification level should be used for initial reliability qualification. Once identified, the LEDs can be properly packaged, stored and handled to avoid subsequent thermal and mechanical damage during the assembly solder attachment and/or repair operation. The present moisture sensitivity standard contains six levels, the lower the level, the longer the devices floor life. PLCC 5050 series are certified at level 2a. This means PLCC 5050 series have a floor life of 4 weeks before PLCC 5050 series need to re-baked.

Table 5. JEDEC characteristics for PLCC 5050

Level	Floor Life		Soak Requirements			
	Time	Conditions	Standard		Accelerated Environment	
			Time (hours)	Conditions	Time (hours)	Conditions
2a	4 weeks	$\leq 30^{\circ}\text{C} / 60\% \text{ RH}$	696 +5/-0	$30^{\circ}\text{C} / 60\% \text{ RH}$	120 +1/-0	$60^{\circ}\text{C} / 60\% \text{ RH}$

Level	Floor Life		Soak Requirements			
	Time	Condition	Standard		Accelerated Environment	
			Time (hours)	Condition	Time (hours)	Condition
1	Unlimited	$\leq 30^{\circ}\text{C} / 85\% \text{ RH}$	168 +5/-0	$85^{\circ}\text{C} / 85\% \text{ RH}$		
2	1 year	$\leq 30^{\circ}\text{C} / 60\% \text{ RH}$	168 +5/-0	$85^{\circ}\text{C} / 60\% \text{ RH}$		
2a	4 weeks	$\leq 30^{\circ}\text{C} / 60\% \text{ RH}$	696 ¹ +5/-0	$30^{\circ}\text{C} / 60\% \text{ RH}$	120 +1/-0	$60^{\circ}\text{C} / 60\% \text{ RH}$
3	168 hours	$\leq 30^{\circ}\text{C} / 60\% \text{ RH}$	192 ¹ +5/-0	$30^{\circ}\text{C} / 60\% \text{ RH}$	40 +5/-0	$60^{\circ}\text{C} / 60\% \text{ RH}$
4	72 hours	$\leq 30^{\circ}\text{C} / 60\% \text{ RH}$	96 ¹ +5/-0	$30^{\circ}\text{C} / 60\% \text{ RH}$	20 +5/-0	$60^{\circ}\text{C} / 60\% \text{ RH}$
5	48 hours	$\leq 30^{\circ}\text{C} / 60\% \text{ RH}$	72 ¹ +5/-0	$30^{\circ}\text{C} / 60\% \text{ RH}$	15 +5/-0	$60^{\circ}\text{C} / 60\% \text{ RH}$
5a	24 hours	$\leq 30^{\circ}\text{C} / 60\% \text{ RH}$	48 ¹ +5/-0	$30^{\circ}\text{C} / 60\% \text{ RH}$	10 +5/-0V	$60^{\circ}\text{C} / 60\% \text{ RH}$
6	Time on tabel (TOL)	$\leq 30^{\circ}\text{C} / 60\% \text{ RH}$	TOL	$30^{\circ}\text{C} / 60\% \text{ RH}$		

Note:

The standard soak time includes a default value of 24 hours for semiconductor manufacturer's exposure time (MET) between bake and bag, and includes maximum time allowed out of the bag at the distributor's facility.

Reliability Test Items

The following table describes operating life, mechanical, and environmental tests performed on PLCC 5050 series.

Table 6. Reliability Test 1

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Temperature and Humidity	60°C / 60%RH	120 hours	No catastrophics
IR Reflow	Peak temp.=255~260°C*3 times	3 times	

Table 7. Reliability Test 2

Stress Test	Stress Conditions	Stress Duration	Failure Criteria
Room Temperature Operating Life	25°C, I _F = max DC (Note 2)	1000 hours	No catastrophics
High Temperature and high Humidity Life	85°C / 85%RH, I _F = 5 mA	1000 hours	
Low Temperature Storage	-40°C	1000 hours	
High Temperature and high Humidity Storage	85°C / 85%RH	1000 hours	
Ambient Temperature Life	25°C, I _F = 20 mA	1000 hours	
Temperature Cycle	-40°C/100°C, 30 min dwell <15min transfer	200 cycles	
Thermal Shock	-40°C / 100°C, 15 min dwell<10 sec transfer	200 cycles	

Notes:

- Reliability test 2 is performed after reliability test 1.
- Depending on the maximum derating curve.
- Failure Criteria:
Electrical failures
V_F Shift ≥10%
Luminous Intensity
I_V Decay ≥ 35%

Color Spectrum and Radiation Pattern

• Beam Angle Characteristic

Table 8. Beam angle Characteristic for PLCC 5050 series

Part Name	Color	2 $\theta_{1/2}$ (Typ.) Lambertian	Unit
ET-5050H-3F1W	Neutral White	120	Deg.

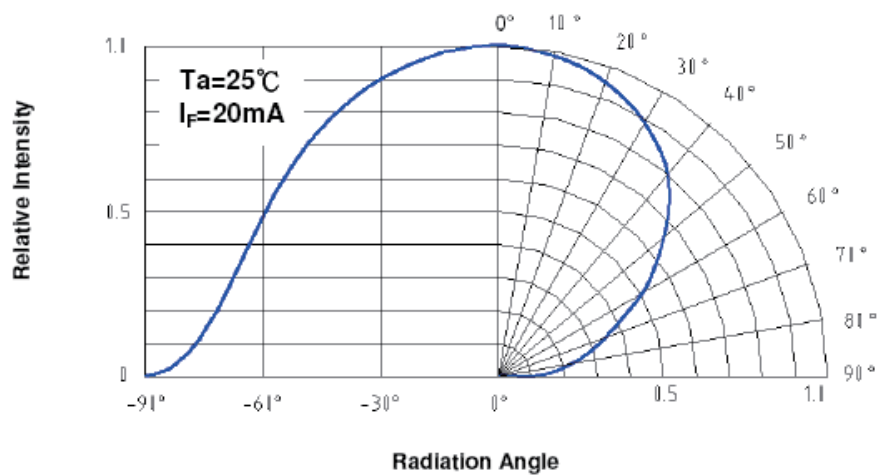


Figure 4. Beam pattern diagram for PLCC 5050 series

• Color Temperature or Dominant Wavelength Characteristics

Table 9. Dominant Wavelength or Peak wavelength or Color Temperature Characteristics at $T_a=25^\circ\text{C}$ for PLCC 5050 series

Part Name	Color	CCT		Unit
		Min.	Max.	
ET-5050H-3F1W	Neutral White	3,800	5,000	K

Notes:

Color Temperature is measured with an accuracy of $\pm 200\text{K}$

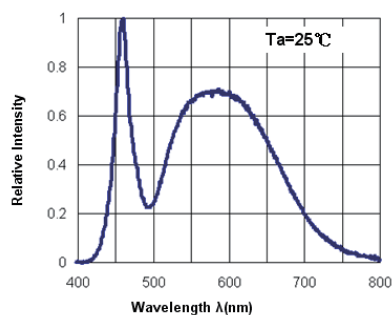


Figure 5: Wavelength & relative intensity for PLCC 5050 series

Optical and Electric Characteristics

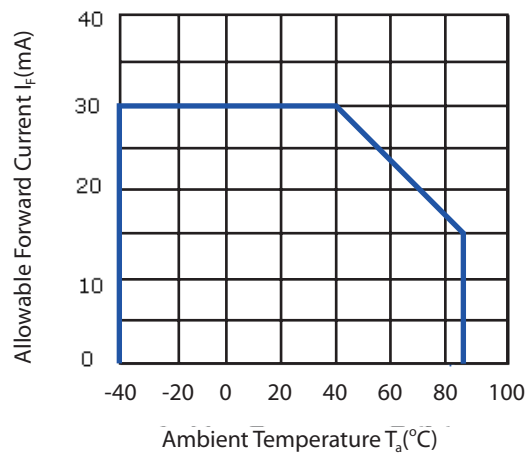


Figure 6. Ambient temperature & forward current for PLCC 5050 series

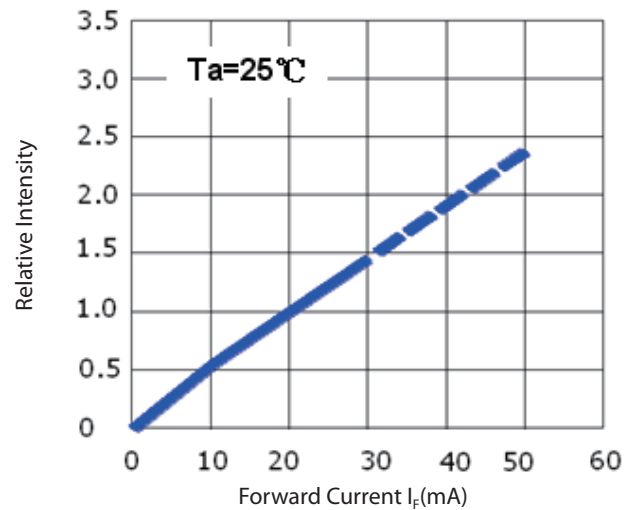


Figure 7. Forward current & relative intensity for PLCC 5050 series

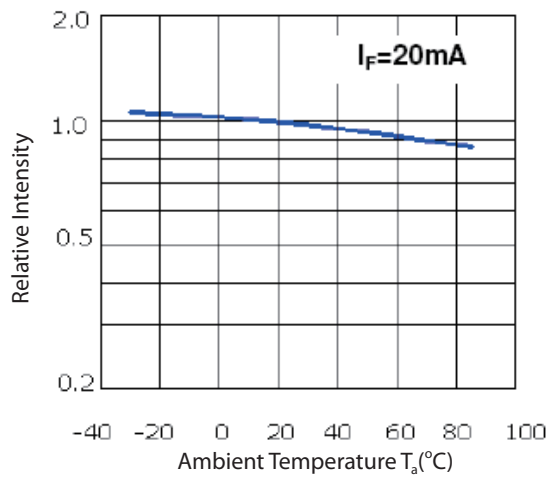


Figure 8. Ambient temperature & relative intensity for PLCC 5050 series

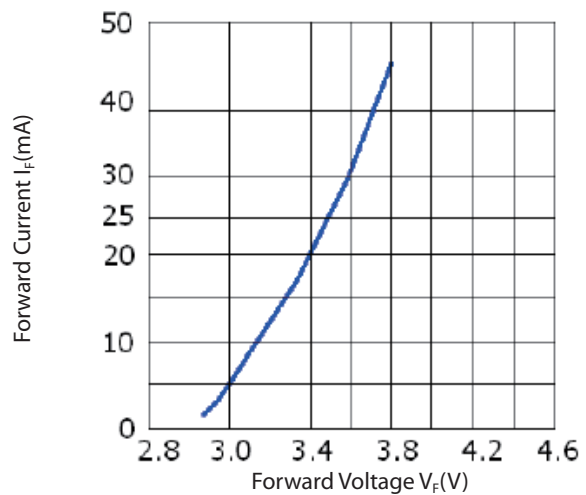


Figure 9. Forward current & forward voltage for PLCC 5050 series

Product Soldering Instructions

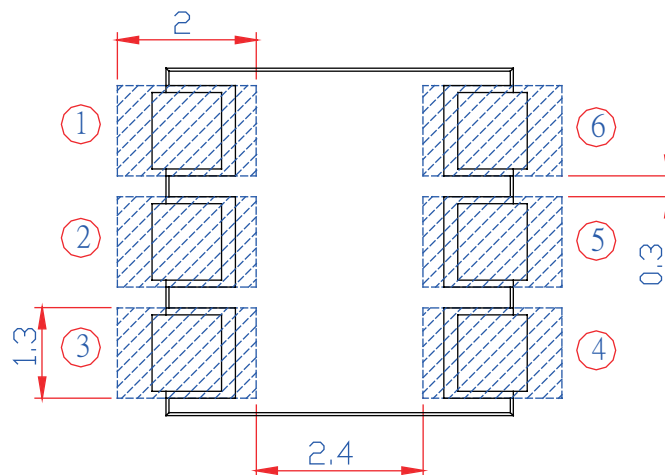


Figure 10. Pad Dimension

Note:

All dimensions are measured in mm.

Reflow Profile

The following reflow soldering profiles are provided for reference. It is recommended that users follow the recommended soldering profile provided by the manufacturer of the solder paste used

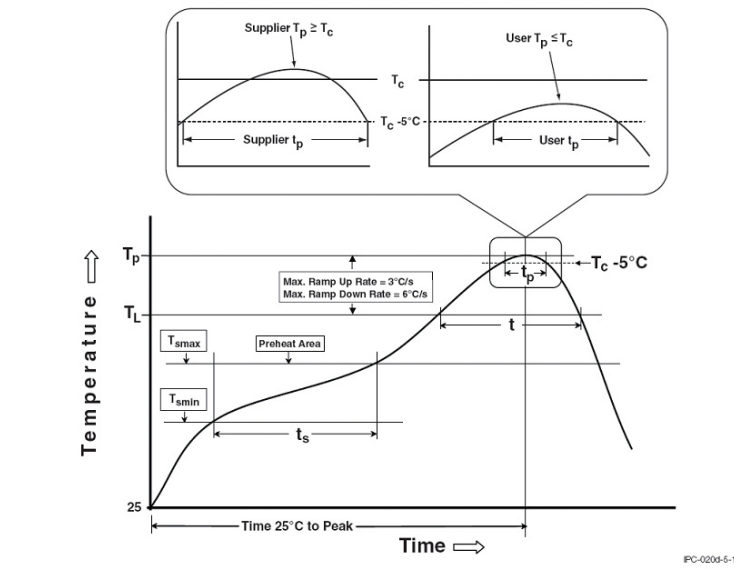


Figure 11. Reflow Profiles

Table 10. Table of Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak		
Temperature min (Tsmmin)	100°C	150 °C
Temperature max (Tsmmax)	150°C	200 °C
Time (Tsmmin to Tsmmax) (ts)	60-120 seconds	60-120 seconds
Average ramp-up rate (Tsmmax to Tp)	3°C/second max.	3 °C/second max.
Liquidous temperature (TL)	183 °C	217 °C
Time at liquidous (tL)	60-150 seconds	60-150 seconds
Peak package body temperature (Tp)*	230 °C ~235°C *	255 °C ~260 °C *
Classification temperature (Tc)	235°C	260 °C
Time (tp)** within 5 °C of the specified classification temperature (Tc)	20** seconds	30** seconds
Average ramp-down rate (Tp to Tsmmax)	6°C/ second max.	6°C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.

Notes:

* Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

Product Packaging Information

Taping Reel

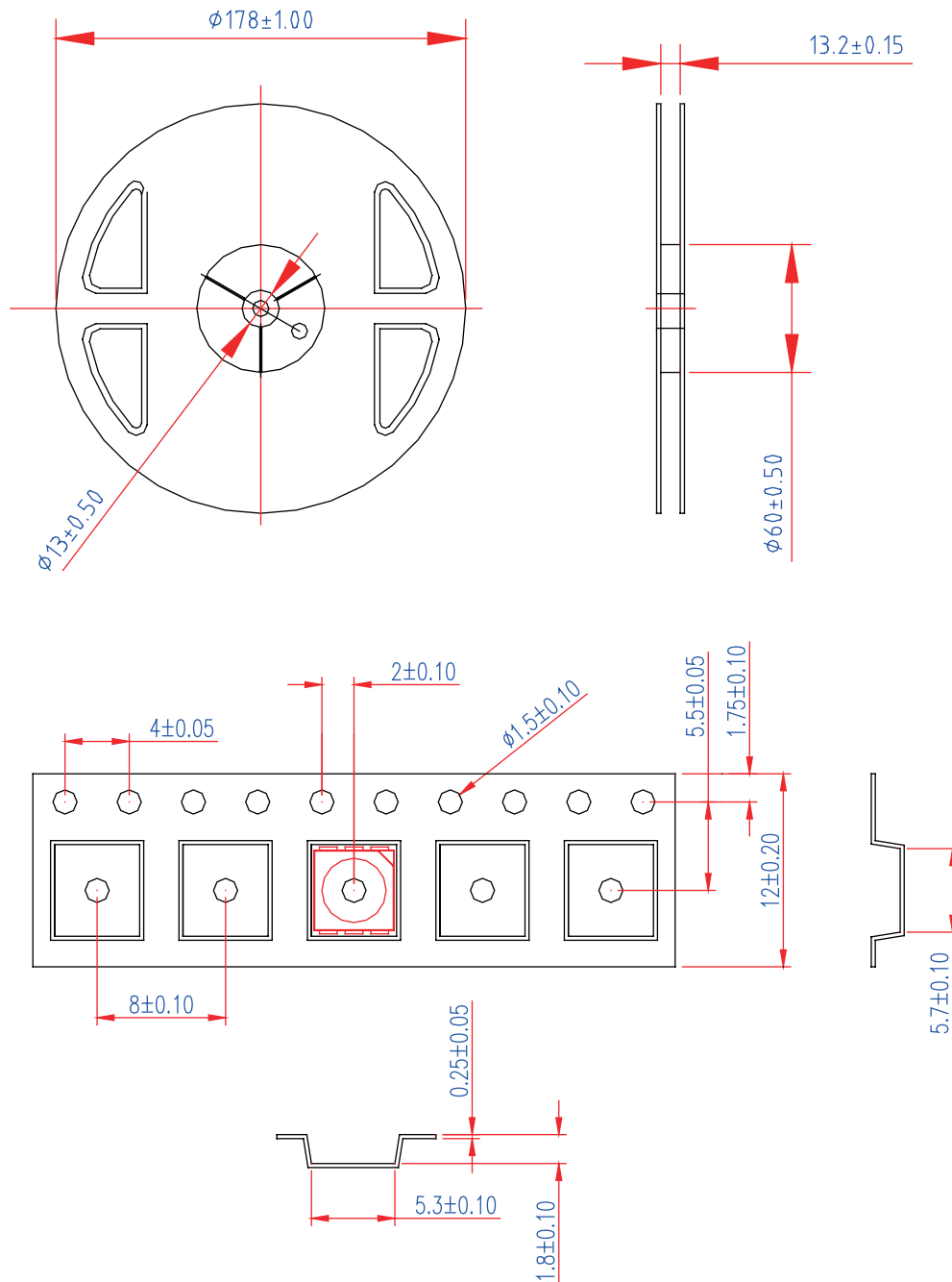


Figure 12. Taping reel dimensions

Packaging

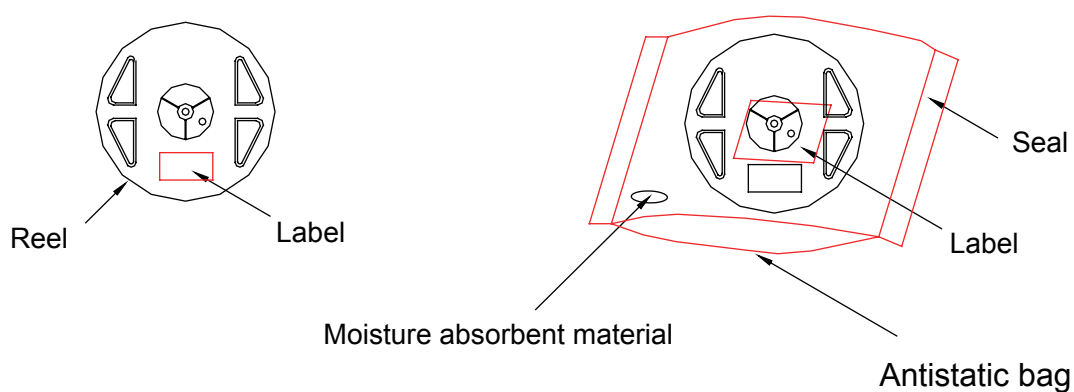


Figure 13. Packaging diagram

Package Label

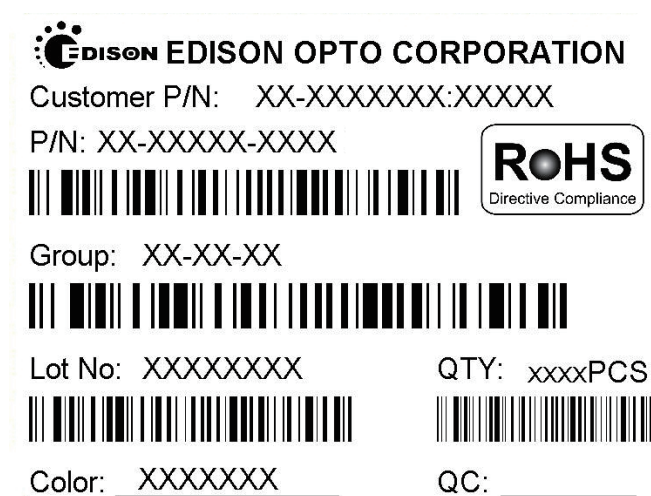


Figure 14. Package label

Table 11. Package dimensions and quantity

Item	Quantity	Total	Dimensions(mm)
Reel	1,000pcs	1,000pcs	Diameter=178
Box	5 reels	5,000pcs	240*235*67
Carton	10 boxes	50,000pcs	500*260*355

Precaution for Use

Storage

1.1 Before opening the package

The LEDs should be kept at $<40^{\circ}\text{C}$ & $<90\%\text{RH}$. The LEDs should be used within a year. When storing the LEDs, moisture proof package with absorbent material (silica gel) is recommended.

1.2 After opening the package

The LEDs should be kept at $\leq 30^{\circ}\text{C}$ & $\leq 60\%\text{RH}$. The LEDs should be soldered within 4 weeks after opening the moisture proof package.

If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with moisture proof package within absorbent material (silica gel). It is also recommended to return the unused LEDs to the original moisture proof package and to seal the moisture proof package again.

If the moisture absorbent material (silica gel) vapors or expires the expiration date, baking treatment should be performed by using the following conditions : 60°C for 20 hours.

The LEDs electrode and leadframe comprise a silver plated copper alloy. The silver surface may be affected by environments. Please avoid conditions which may cause the LEDs being corroded or discolored. The corrosion or discoloration might lower solderability or affect optical characteristics.

Please avoid rapid transition in ambient temperature, especially in high humidity environments where condensation can occur.

Static electricity

The products are sensitive to static electricity and highly taken care when handling them.

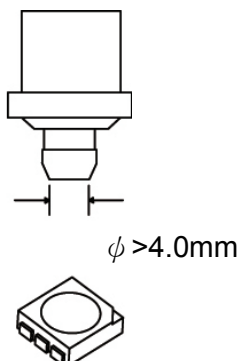
Static electricity or surge voltage will damage the LEDs. It is recommended to wear an anti-electrostatic wristband or an anti-electrostatic glove when handling the LEDs.

All devices, equipments and machinery must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LEDs.

Pick and Place

Recommended conditions: Outer nozzle $> \phi 4.0 \text{ mm}$

*Avoid direct contact to the encapsulant with picking up nozzle. Failure to comply might result in pick and place processes or damage to encapsulant. In the worst cases, catastrophic failure of the LEDs due to wire deformation and/or breakage.



Notes:

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EDISON OPTO reserves the right to make changes at any time without notice to any products in order to improve reliability, function or design.

EDISON OPTO products are not authorized for use as critical components in life support devices or systems without the express written approval from the managing director of EDISON OPTO.

Forward Voltage Ranks

Table 12. Forward voltage rank at Ta=25°C

Bin	Condition	Min	Max	Unit
UJ	I _f =20mA/chip	2.8	3.0	V
UK		3.0	3.2	
UL		3.2	3.4	
UM		3.4	3.6	
UN		3.6	3.8	

Note:

Forward voltage measurement allowance is $\pm 0.1V$.

Luminous Intensity Ranks

Table 13. Luminous intensity rank at Ta=25°C

Bin	Condition	Min	Max	Unit
ZL	I _f =20mA/chip	2,650	3,250	mcd
ZM		3,250	3,950	
ZN		3,950	4,850	
ZO		4,850	5,950	
ZP		5,950	7,250	

Note:

Luminous Intensity Measurement Allowance is $\pm 10\%$

CIE Chromaticity Diagram

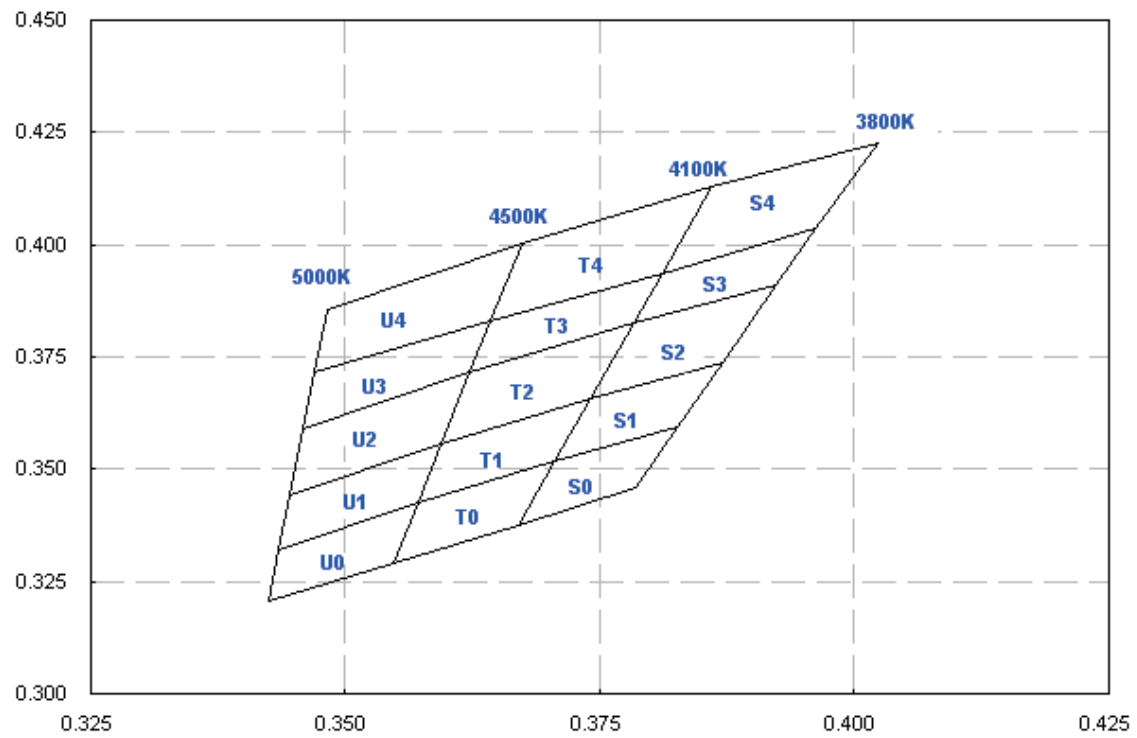


Figure 15. PLCC 5050 series chromaticity diagram

Color Bin

Table 14. Color Bin S0-U4 at $I_f=20\text{mA/chip}$, $T_a=25^\circ\text{C}$ for PLCC 5050 series

Bin	Chromaticity Coordinate				
S0	X	0.3825	0.3785	0.3670	0.3705
	Y	0.3529	0.3460	0.3377	0.3519
S1	X	0.3470	0.3870	0.3825	0.3705
	Y	0.3658	0.3738	0.3595	0.3519
S2	X	0.3782	0.3923	0.3870	0.3740
	Y	0.3824	0.3909	0.3738	0.3658
S3	X	0.3782	0.3811	0.3962	0.3923
	Y	0.3824	0.3937	0.4035	0.3909
S4	X	0.3859	0.4022	0.3962	0.3811
	Y	0.4129	0.4227	0.4035	0.3937
T0	X	0.3705	0.3670	0.3548	0.3570
	Y	0.3519	0.3377	0.3290	0.3425
T1	X	0.3622	0.3782	0.3705	0.3740
	Y	0.3716	0.3824	0.3519	0.3658
T2	X	0.3594	0.3824	0.3740	0.3594
	Y	0.3556	0.3716	0.3658	0.3556
T3	X	0.3642	0.3811	0.3782	0.3622
	Y	0.3828	0.3937	0.3824	0.3716
T4	X	0.3672	0.3859	0.3811	0.3642
	Y	0.4002	0.4129	0.3937	0.3828
U0	X	0.3570	0.3548	0.3425	0.3433
	Y	0.3425	0.3290	0.3208	0.3320
U1	X	0.3444	0.3433	0.3570	0.3594
	Y	0.3442	0.3320	0.3425	0.3556
U2	X	0.3622	0.3594	0.3444	0.3457
	Y	0.3716	0.3556	0.3442	0.3591
U3	X	0.3642	0.3622	0.3457	0.3469
	Y	0.3828	0.3716	0.3591	0.3717
U4	X	0.3642	0.3672	0.3481	0.3469
	Y	0.3828	0.4002	0.3856	0.3717

Note:

Color coordinates measurement allowance is ± 0.01